INTERNATIONAL VISITING SCHOLAR ACADEMY



American Cultural Engagement and Professional Development



CENTER FOR INTERNATIONAL STUDIES AND PROGRAMS



International Visiting Scholar Academy (IVSA)

An increasing number of International Institutes have started to realize the importance of internationalizing their campuses, to achieve this, one requirement is that faculty members in a post-secondary setting will need to have a study abroad experience to be promoted.

Program Goal

The IVSA program is developed to serve international scholars who are interested in coming to University of Toledo to participate in a specialty program that consist of a series of professional development workshops, seminars and cultural immersion activities for their continuous improvement in teaching, research, and services related to their field. Increase UT cross-cultural scholarly activities and communications.

Target Audience

In this program, visiting scholars (J-1 research category visa holders) may be current faculty in post-secondary settings, researchers, and post-doctoral students seeking faculty positions in post-secondary settings.

Program Time and Length

The program starts every January/August and last for 6 months or 12 months.

Application Procedure

- 1. Send the Application Package to Sara Clark (Sara.Clark2@utoledo.edu), the Director of CISP Office. Application Package should include:
 - Completed Application Form
 - Updated CV or Resume
 - Statement of Interests / self-recommendation letter
- The submitted application package will be reviewed within 2 week after submission. CISP will send official invitation letter to accepted visiting scholars.
- 3. Admitted visiting scholars will be issued a Short-term scholar DS-2019 for the program.
- 4. CISP will assist admitted visiting scholar to arrange visa interview for the visit.

Program Fee

- i. Academic Program Fee: \$6,500 per semester
- ii. Living Expenses: (per semester)
 - Accommodation: \$3,000 \$4,800
 - Meal Plan: \$2,000 \$3,000

*Note: All fees are shown in U.S. Dollars.

Program Structure

i. <u>Research Collaboration</u> (supervised research activities collaborated with UT professors majored in specific academic field):

Invited visiting scholars will be paired up with UT faculty members whose research focuses are aligned with the visiting scholars' interests of research collaboration. Assigned faculty member will arrangement academic activities to facilitate the collaborated research projects.

ii. Academic Enrichment (Workshops offered by CISP biweekly):

CISP will partner with various UT stakeholders to offer the academic enrichment sessions. Partners will be compensated. The workshops take place during the academic calendar starting in September for fall semester or in January for spring semester.

- Workshop 1: Introduction and Program Overview/Immigration Clearance
- · Workshop 2: American Education System and Classroom Culture
- Workshop 3: Curriculum and Instructions & Teaching a college engineering course
- Workshop 4: Assessment of student learning
- Workshop 5: Scholar leadership and professional development
- · Workshop 6: Writing Research Paper in English
- Workshop 7: Research and Innovations
- Workshop 8: Online teaching and course design

iii. Cultural Immersion (social events offered by CISP monthly):

- Thanksgiving Dinner (Fall)
- Outlet Mall Shopping Trip (Fall)
- Sandpiper Boat Tour (Fall)
- American Football Experience (Fall)
- I-Village (Fall)
- Ford Museum (Fall)
- International Auto Show (Spring)
- Ski Trip (Spring)



- I-Dinner (Spring)
- International Festival (Spring)
- American Basketball Experience (Spring)
- Shopping Trip every Friday (Fall/Spring)

iv. Electives Seminars (schedule and availability determined by department):

Examples of engineering seminars:

- Wide Bandgap Semiconductors and Adaptive Control: Game Changers for Next Generation Power Electronics.
- Optimization of Power Electronics for Wide Band-Gap Semiconductors: Opportunities and Challenges.
- The new measurement approaches in RF Nano electronics, Near Field Scanning Microwave
- Microscopy (NSMM)
- Gallium Based Semiconductors for Power Electronics: Materials to Applications and Back.
- 3D Printing for Validation of Multidisciplinary Design, Analysis, and Optimization (MDAO)
- Effective Visual Communications in Engineering

Highlights of the University of Toledo

- UT is a public comprehensive research Institution
- UT has over 272 academic programs
- UT has 16,000+ Undergraduate Students, 4,200+ Graduate Students
- UT has 1,800+ International students from 84 countries
- UT is the best four-year college in Ohio for affordability, flexibility and student services
- UT is one of the top 100 most beautiful campuses in U.S.

Contact us

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